PD - 95244

International

IRF7601PbF

- Generation V Technology
- Ultra Low On-Resistance
- N-Channel MOSFET
- Very Small SOIC Package
- Low Profile (<1.1mm)
- Available in Tape & Reel
- Fast Switching
- Lead-Free
- Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The new Micro8 package, with half the footprint area of the standard SO-8, provides the smallest footprint available in an SOIC outline. This makes the Micro8 an ideal device for applications where printed circuit board space is at a premium. The low profile (<1.1mm) of the Micro8 will allow it to fit easily into extremely thin application environments such as portable electronics and PCMCIA cards.

Absolute Maximum Ratings

	Parameter	Max.	Units
I _D @ T _A = 25°C	Continuous Drain Current, VGS @ 4.5V	5.7	
I _D @ T _A = 70°C	Continuous Drain Current, V _{GS} @ 4.5V	4.6	A
I _{DM}	Pulsed Drain Current ①	30	
P _D @T _A = 25°C	Power Dissipation	1.8	W
	Linear Derating Factor	14	m₩/ºC
V _{GS}	Gate-to-Source Voltage	± 12	V
dv/dt	Peak Diode Recovery dv/dt 2	5.0	V/ns
T _{J,} T _{STG}	Junction and Storage Temperature Range	-55 to + 150	°C

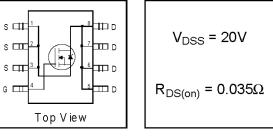
Thermal Resistance

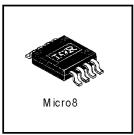
	Parameter	Тур.	Max.	Units
R _{eja}	Maximum Junction-to-Ambient®		70	°C/W

All Micro8 Data Sheets reflect improved Thermal Resistance, Power and Current -Handling Ratings- effective only for product marked with Date Code 505 or later .

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HEXFET[®] Power MOSFET





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	Parameter	Min.	Тур.	Max.	Units	Conditions
V(BR)DSS	Drain-to-Source Breakdown Voltage	20			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{\rm J}$	Breakdown Voltage Temp. Coefficient		0.024	—-	V/⁰C	Reference to 25°C, I_D = 1mA
	Static Drain-to-Source On-Resistance			0.035	0	V _{GS} = 4.5V, I _D = 3.8A ③
R _{DS(on)}	Static Drain-to-Source Off-Resistance			0.050	Ω	V_{GS} = 2.7V, I_{D} = 1.9A (3)
$V_{\text{GS(th)}}$	Gate Threshold Voltage	0.70			V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
g fs	Forward Transconductance	6.1			S	V _{DS} = 10V, I _D = 1.9A
I _{DSS}	Drain-to-Source Leakage Current			1.0	μA	V _{DS} = 16V, V _{GS} = 0V
1088	Brain to Course Leakage Current			25	μΛ	V _{DS} = 16V, V _{GS} = 0V, T _J = 125°C
I _{GSS}	Gate-to-Source Forward Leakage			-100	nA	V _{GS} = -12V
.622	Gate-to-Source Reverse Leakage			100	17.5	V _{GS} = 12V
Qg	Total Gate Charge		14	22		I _D = 3.8A
Q _{gs}	Gate-to-Source Charge		2.0	3.0	nC	V _{DS} = 16V
Q _{gd}	Gate-to-Drain ("Miller") Charge		6.3	9.5		V_{GS} = 4.5V, See Fig. 6 and 9 3
t _{d(on)}	Turn-On Delay Time		5.1	—–		V _{DD} = 10V
tr	Rise Time		47	—–	ne	I _D = 3.8A
t _{d(off)}	Turn-Off Delay Time		24		ns	$R_G = 6.2\Omega$
t _f	Fall Time		32			R_D = 2.6 Ω , See Fig. 10 ③
Ciss	Input Capacitance		650			V _{GS} = 0V
C _{OSS}	Output Capacitance		300		pF	V _{DS} = 15V
Crss	Reverse Transfer Capacitance		150			<i>f</i> = 1.0MHz, See Fig. 5

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions		
Is	Continuous Source Current			1.8		MOSFET symbol		
	(Body Diode)			1.0	A	showing the		
Ism	Pulsed Source Current			30	30	30		integral reverse
	(Body Diode) ①					p-n junction diode.		
V _{SD}	Diode Forward Voltage			1.2	V	T _J = 25°C, I _S = 3.8A, V _{GS} = 0V ③		
trr	Reverse Recovery Time		51	77	ns	T _J = 25°C, I _F = 3.8A		
Q _{rr}	Reverse RecoveryCharge		69	100	nC	di/dt = 100A/µs ③		

Notes:

① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)

 ③ Pulse width \leq 300µs; duty cycle \leq 2%.

O I_{SD} \leq 3.8A, di/dt \leq 96A/µs, V_{DD} \leq $V_{(\text{BR})\text{DSS}},$ T_J \leq 150°C 2

G Surface mounted on FR-4 board, t \leq 10sec.

International **tor** Rectifier

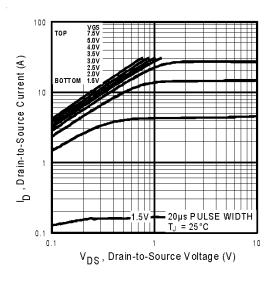
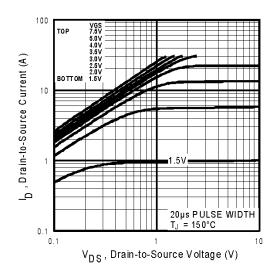
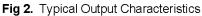


Fig 1. Typical Output Characteristics





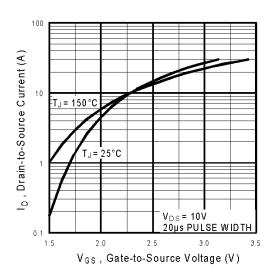


Fig 3. Typical Transfer Characteristics

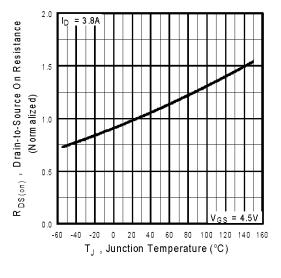


Fig 4. Normalized On-Resistance Vs. Temperature

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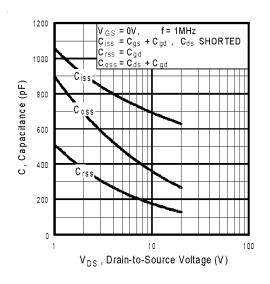


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

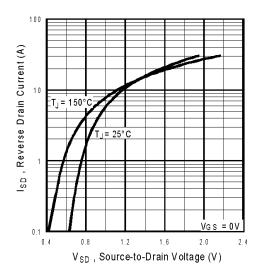


Fig 7. Typical Source-Drain Diode Forward Voltage

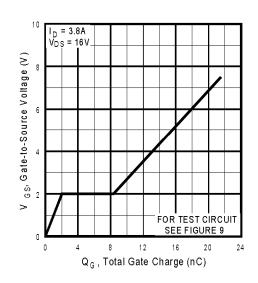


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

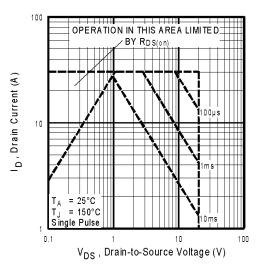
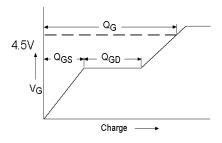


Fig 8. Maximum Safe Operating Area

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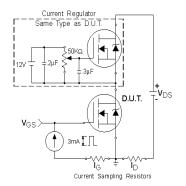


Fig 9b. Gate Charge Test Circuit

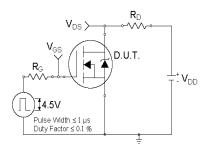


Fig 10a. Switching Time Test Circuit

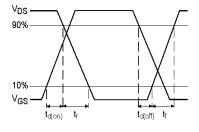


Fig 10b. Switching Time Waveforms

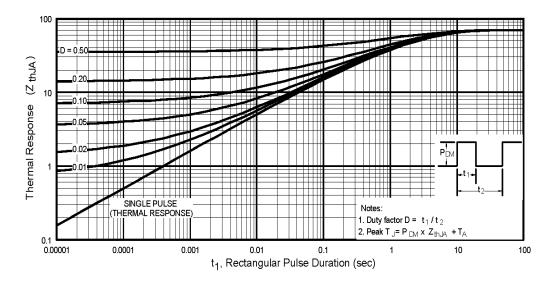
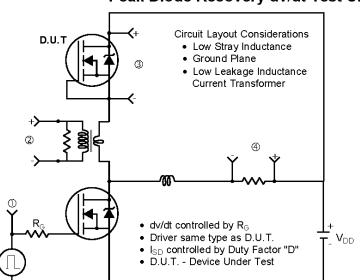


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

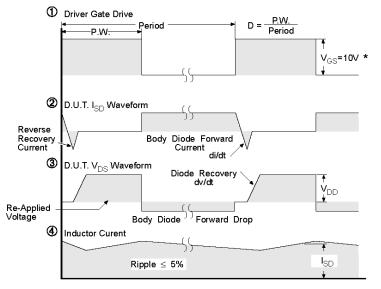
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Peak Diode Recovery dv/dt Test Circuit



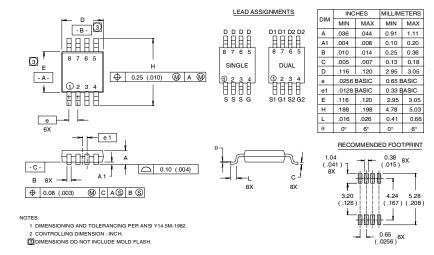
* V_{GS} = 5V for Logic Level Devices

Fig 12. For N-Channel HEXFETS

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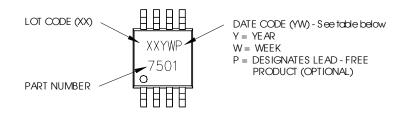
Micro8 Package Outline

Dimensions are shown in milimeters (inches)



Micro8 Part Marking Information

EXAMPLE: THIS IS AN IRF7501



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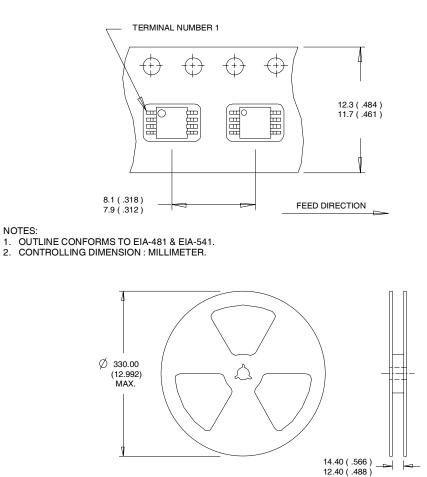
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YEAR	Y	WORK WEEK
2001 2002 2003	A B C	27 28 29
2003 2004 2005 2006 2007 2008 2009 2010	C D E F G H J K	30 50
2010		51 52

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Micro8 Tape & Reel Information

Dimensions are shown in millimeters (inches)



NOTES : 1. CONTROLLING DIMENSION : MILLIMETER. 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

> Data and specifications subject to change without notice. This product has been designed and qualified for the Consumer market. Qualification Standards can be found on IR's Web site.

> > International

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